



**Vin = 42V to 52V**

**160V / 180V @ 900mA  
Duty Cycle 50%  
for 12 seconds (MAX.)**



**Assembly Notes:**  
Built on PMP30162 Rev\_A PCB  
Ref. Des. > 99 are reworked parts

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Number: PMP30162 | Rev: B  
SVN Rev: Version control disabled  
Drawn By: R. Scibilia  
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Designed for: Public Release	Mod. Date: 12/20/2016
Project Title: 180V@0.9A CC and CV Cap Charger SEPIC	
Sheet Title: 180V@0.9A CC and CV Cap Charger SEPIC	
Assembly Variant: [No Variations]	Sheet: 1 of 1
File: PMP30162 Rev_B_SchDoc	Size: A4
Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	

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